



THE DATASHEET OF DMN3006SCA6-7

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Source-Source Voltage			V _{SSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Source Current (Note 5) V _{GS} = 8V	Steady State	T _A = +25°C	I _S	13.0	A
		T _A = +70°C		10.5	
Continuous Source Current (Note 5) V _{GS} = 4.5V	Steady State	T _A = +25°C	I _S	11.5	A
		T _A = +70°C		9.0	
Pulsed Source Current (Note 6)			I _{SM}	80	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P_D	0.8	W
Thermal Resistance, Junction to Ambient @ $T_A = +25^\circ\text{C}$ (Note 7)	$R_{\theta JA}$	162	$^\circ\text{C/W}$
Power Dissipation (Note 5)	P_D	1.8	W
Thermal Resistance, Junction to Ambient @ $T_A = +25^\circ\text{C}$ (Note 5)	$R_{\theta JA}$	68	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Source-Source Breakdown Voltage	BV_{SSS}	30	—	—	V	$V_{GS} = 0\text{V}, I_S = 1\text{mA}$
Zero Gate Voltage Drain Current $T_J = +25^\circ\text{C}$	I_{SSS}	—	—	1	μA	$V_{SS} = 24\text{V}, V_{GS} = 0\text{V}$
Gate-Source Leakage	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 20\text{V}, V_{SS} = 0\text{V}$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$V_{GS(TH)}$	1.3	—	2.2	V	$V_{SS} = 10\text{V}, I_S = 1\text{mA}$
Static Source-Source On-Resistance	$R_{SS(ON)}$	2.5	4.6	5.5	m Ω	$V_{GS} = 10\text{V}, I_S = 5\text{A}$
		2.7	4.8	7.2		$V_{GS} = 8\text{V}, I_S = 5\text{A}$
		3.0	6.3	9.0		$V_{GS} = 4.5\text{V}, I_S = 5\text{A}$
Diode Forward Voltage	V_{SS}	—	0.95	1.2	V	$V_{GS} = 0\text{V}, I_S = 5\text{A}$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C_{ISS}	—	2235	—	pF	$V_{SS} = 15\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$
Output Capacitance	C_{OSS}	—	414	—		
Reverse Transfer Capacitance	C_{RSS}	—	274	—		
Total Gate Charge	Q_g	—	17.7	—	nC	$V_{SS} = 15\text{V}, V_{GS} = 4.5\text{V}, I_S = 5\text{A}$
Gate-Source Charge	Q_{gs}	—	4.9	—		
Gate-Drain Charge	Q_{gd}	—	6.1	—		
Gate Charge at V_{TH}	$Q_{g(TH)}$	—	3.0	—		
Turn-On Delay Time	$t_{D(ON)}$	—	5.6	—	ns	$V_{SS} = 15\text{V}, V_{GS} = 10\text{V}, I_S = 5\text{A}$
Turn-On Rise Time	t_R	—	8.7	—		
Turn-Off Delay Time	$t_{D(OFF)}$	—	41.6	—		
Turn-Off Fall Time	t_F	—	20.9	—		

- Notes:
- Device mounted on FR-4 material with 1inch^2 (6.45cm^2), 2oz. (0.071mm thick) Cu.
 - Repetitive rating, pulse width limited by junction temperature.
 - Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to production testing.

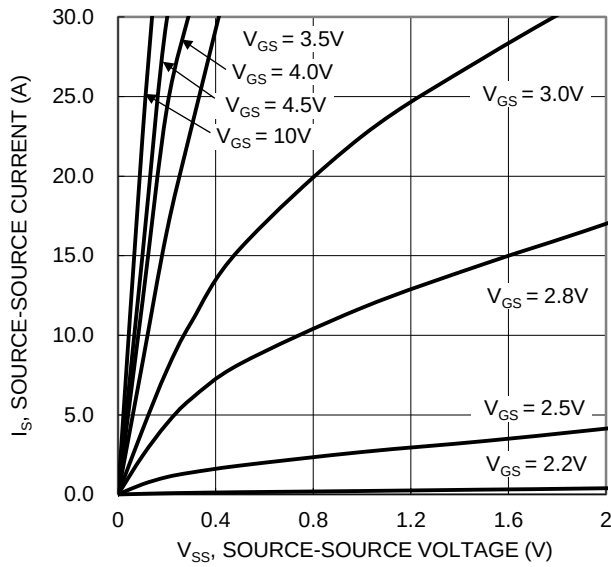


Figure 1. Typical Output Characteristic

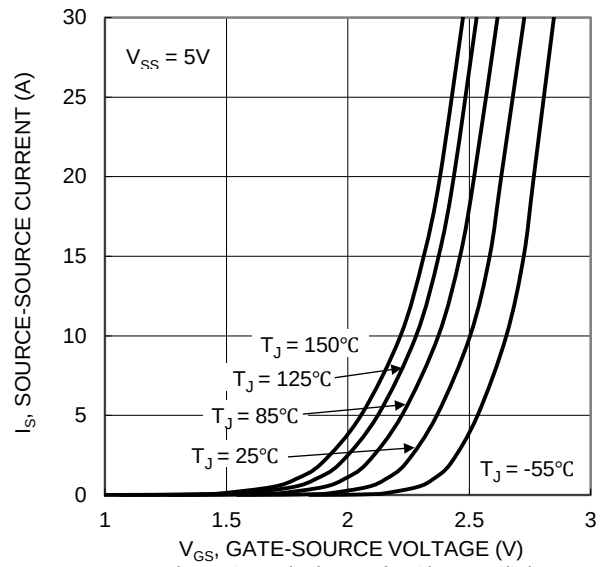


Figure 2. Typical Transfer Characteristic

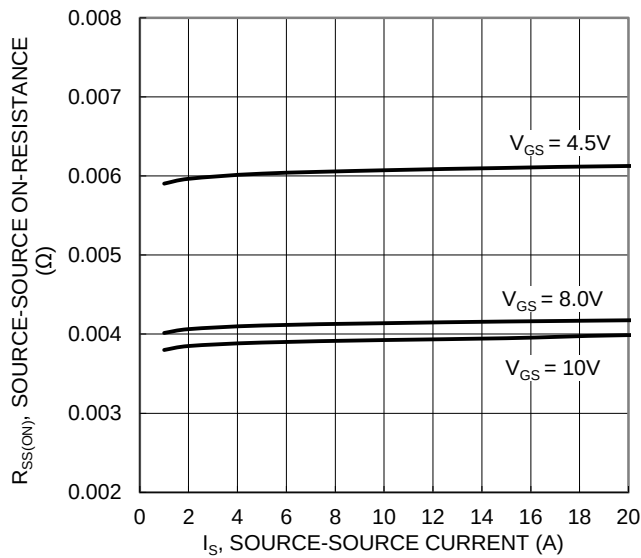


Figure 3. Typical On-Resistance vs. Source Current and Gate Voltage

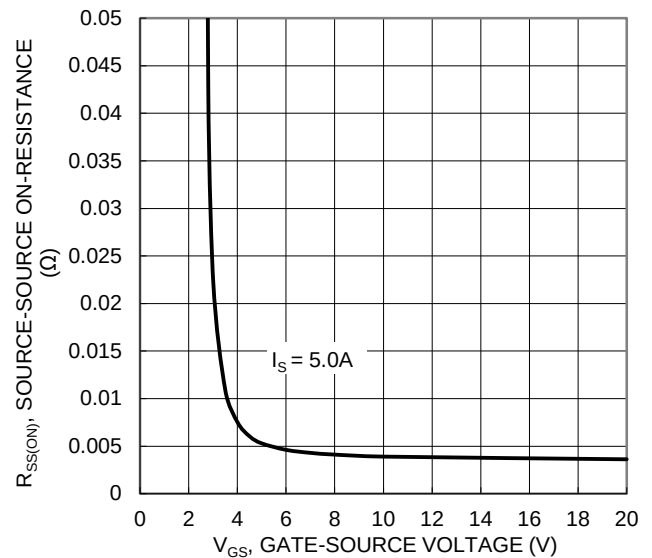


Figure 4. Typical Transfer Characteristic

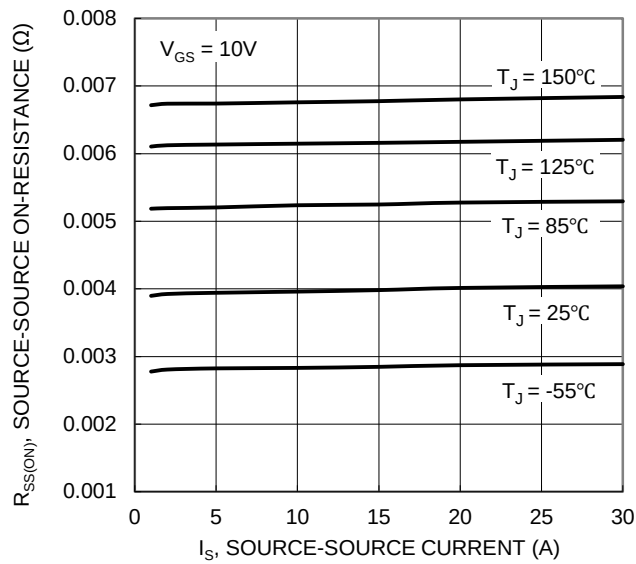


Figure 5. Typical On-Resistance vs. Source Current and Junction Temperature

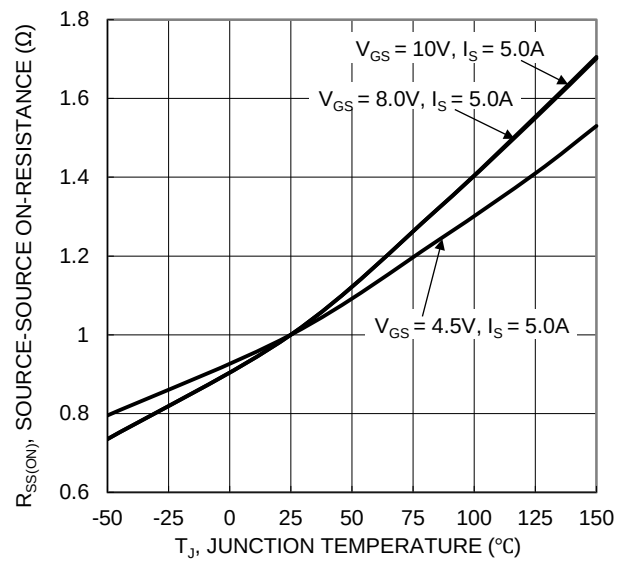


Figure 6. On-Resistance Variation with Junction Temperature

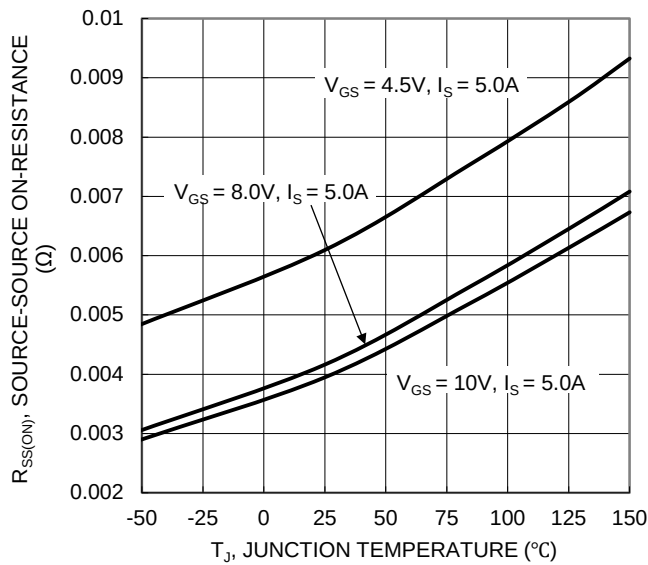


Figure 7. On-Resistance Variation with Junction Temperature

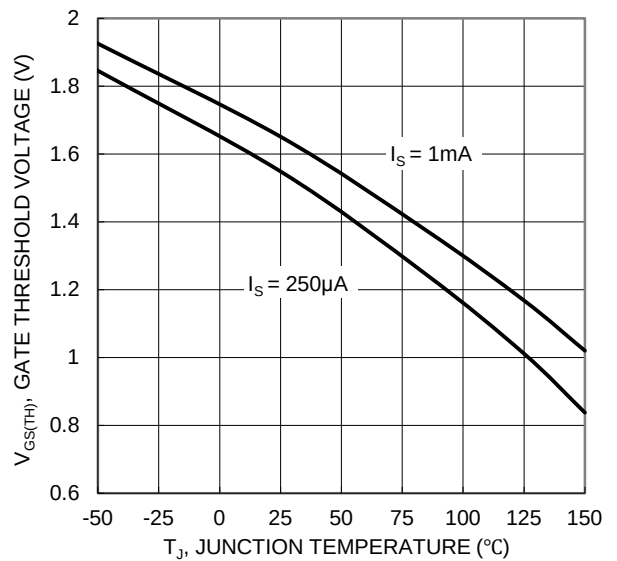


Figure 8. Gate Threshold Variation vs. Junction Temperature

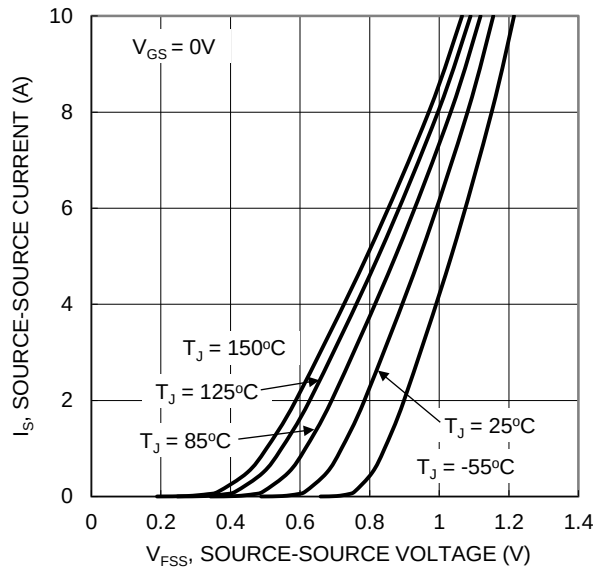


Figure 9. Diode Forward Voltage vs. Current

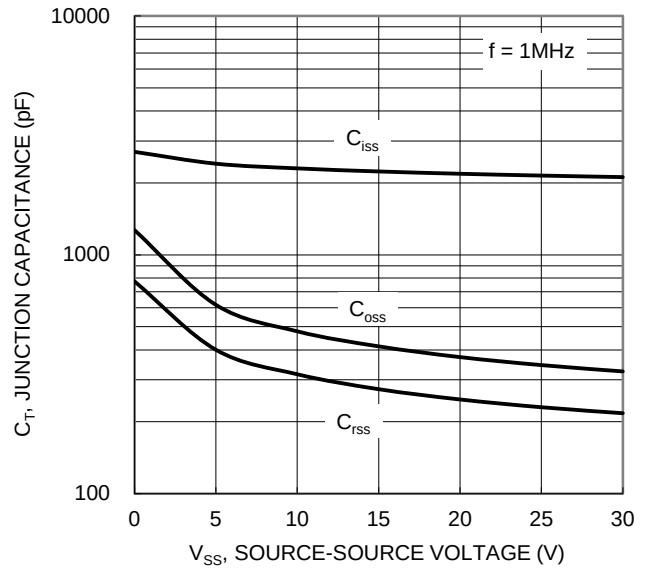


Figure 10. Typical Junction Capacitance

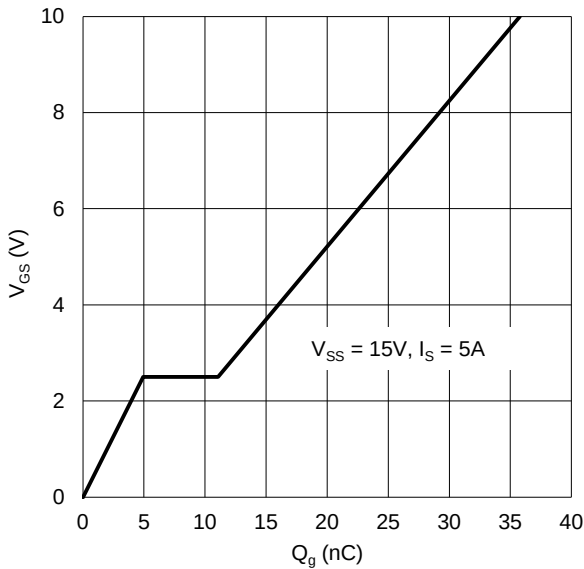


Figure 11. Gate Charge

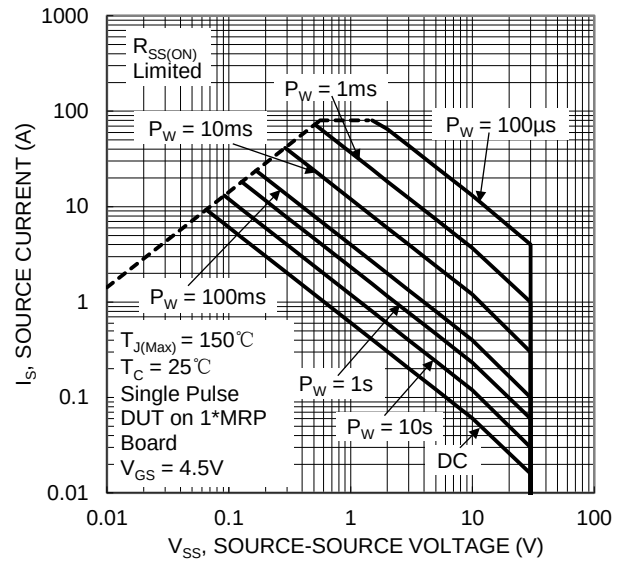


Figure 12. SOA, Safe Operation Area

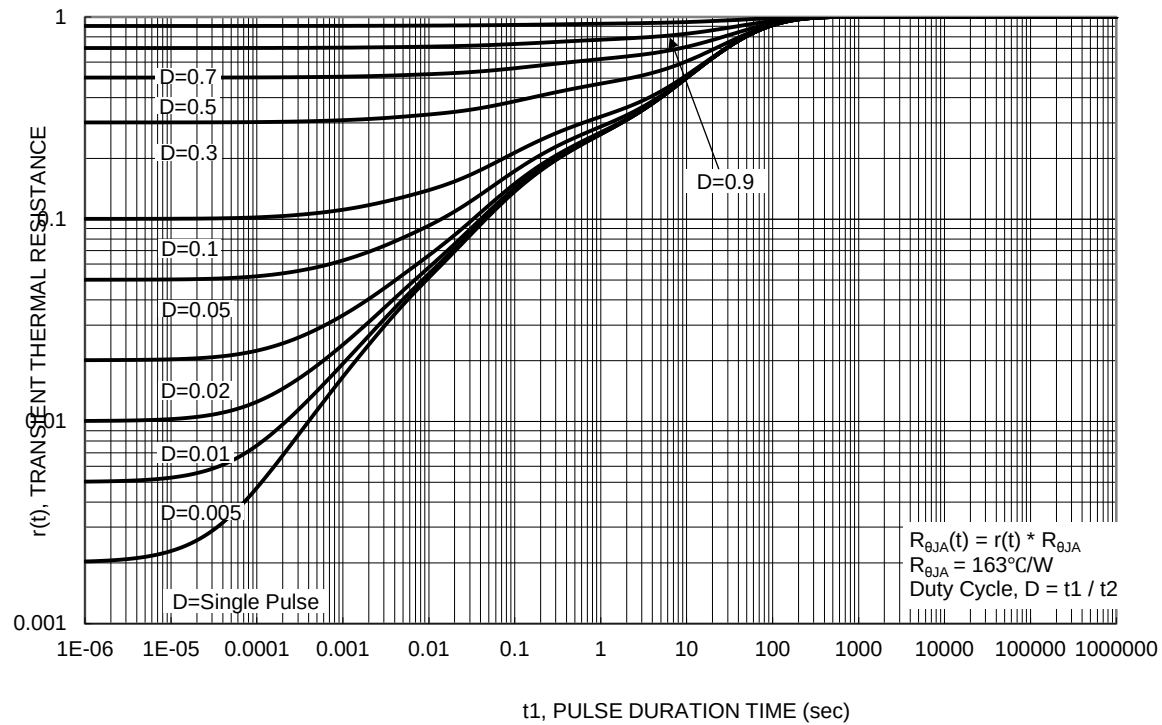
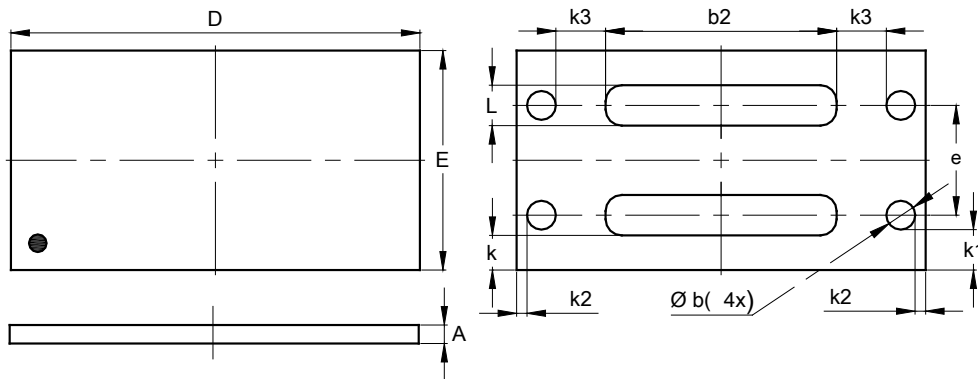


Figure 13. Transient Thermal Resistance

Package Outline Dimensions

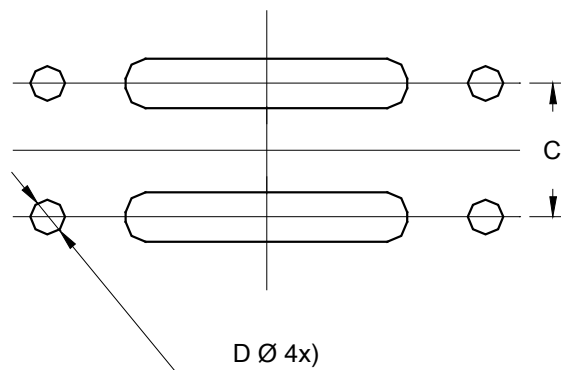
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



X4-DSN3519-6			
Dim	Min	Max	Typ
A	0.09	0.16	0.11
b	--	--	0.25
b2	--	--	2.00
D	3.45	3.55	3.50
E	1.85	1.95	1.90
e	--	--	0.95
k	--	--	0.30
k1	--	--	0.35
k2	--	--	0.085
k3	--	--	0.415
L	--	--	0.35
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	0.95
X	0.25

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